

Amendments to the Specification

Prior to examination on the merits, please amend the paragraph starting on page 3, line 4 as follows:

Preferably, prior to the provision of the semiconductor body on the flexible foil, a part thereof that is situated between the apertures in the insulating layer is provided with an electrically insulating fixing agent on which the semiconductor body is placed and the height of which determines the distance between the semiconductor body and the flexible foil. This has, inter alia, the important advantage that minimum stress is imparted on the conductive vias and the underlying part of the foil, as a result of which the reliability of the device is increased. In this manner, regulating and checking (~~controlling~~?) the electrical insulation by means of a synthetic resin envelope between the semiconductor body and the foil can be improved too.